



Our Docket No: 42390P16893

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of: )

TAN TZYY HAW, ET AL. )

Application No: 10/609,203 )

Filed: June 26, 2003 )

For: IMPROVING BALL GRID ARRAY )  
SOLDER JOINT RELIABILITY )

Examiner: Johnson, Jonathan J.

Art Unit: 1725

**PRELIMINARY AMENDMENT**

Mail Stop: RCE  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Prior to examination of the above-referenced application, please enter the following amendments and consider the following remarks.

**FIRST CLASS CERTIFICATE OF MAILING**

I hereby certify that I am causing the above-referenced correspondence to be deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and that this paper or fee has been addressed to the Mail Stop RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date of Deposit: October 19, 2005

Name of Person Mailing Correspondence: Debbie Casias

Debbie Casias  
Signature

10/19/05  
Date